

# Silicon Fast Recovery Diode

**$V_{RRM} = 100 \text{ V - } 600 \text{ V}$**   
 **$I_F = 16 \text{ A}$**

## Features

- High Surge Capability
- Types up to 600 V  $V_{RRM}$

**DO-4 Package**



**Maximum ratings, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified ("R" devices have leads reversed)**

Parameter	Symbol	Conditions	FR16B(R)02	FR16D(R)02	FR16G(R)02	FR16J(R)02	Unit
Repetitive peak reverse voltage	$V_{RRM}$		100	200	400	600	V
RMS reverse voltage	$V_{RMS}$		70	140	280	420	V
DC blocking voltage	$V_{DC}$		100	200	400	600	V
Continuous forward current	$I_F$	$T_C \leq 100^\circ\text{C}$	16	16	16	16	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_p = 8.3 \text{ ms}$	225	225	225	225	A
Operating temperature	$T_j$		-65 to 150	-65 to 150	-65 to 150	-65 to 150	$^\circ\text{C}$
Storage temperature	$T_{stg}$		-65 to 175	-65 to 175	-65 to 175	-65 to 175	$^\circ\text{C}$

**Electrical characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	FR16B(R)02	FR16D(R)02	FR16G(R)02	FR16J(R)02	Unit
Diode forward voltage	$V_F$	$I_F = 16 \text{ A}, T_j = 25^\circ\text{C}$	1.4	1.4	1.4	1.4	V
Reverse current	$I_R$	$V_R = 100 \text{ V}, T_j = 25^\circ\text{C}$ $V_R = 100 \text{ V}, T_j = 150^\circ\text{C}$	25	25	25	25	$\mu\text{A}$
<b>Recovery Time</b>							
Maximum reverse recovery time	$T_{RR}$	$I_F=0.5 \text{ A}, I_R=1.0 \text{ A},$ $I_{RR}=0.25 \text{ A}$	200	200	200	250	nS
<b>Thermal characteristics</b>							
Thermal resistance, junction - case	$R_{thJC}$		1.5	1.5	1.5	1.5	$^\circ\text{C}/\text{W}$

